





1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Very Low Forward Voltage Drop
- Totally Lead-Free & Fully RoHS Compliant(Note 1 & 2)
- Halogen and Antimony Free."Green" Device(Note 3)

Mechanical Data

- Case: SOD123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe) Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band
- Weight: 0.01 grams (Approximate)



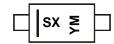
Ordering Information (Note 4)

Part Number	Case	Packaging
B130LAW-7-F	SOD123	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



SX = Product Type Marking Code

YM = Date Code Marking Y = Year (ex: E = 2017)

M = Month (ex: 9 = September)

Date Code Kev

Year	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024
Code	Α	В	С	D	Е	F	G	Н	I	J	K	L

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM	30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Forward Current	I _{F(AV)}	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	12	А



Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	450	mW
Typical Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	222	°C/W
Operating Temperature Range (See Figure 5)	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

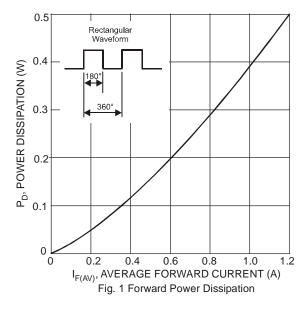
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

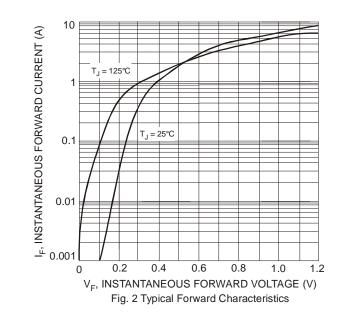
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	30			V	$I_R = 1.5 \text{mA}$
		_	0.25	_		$I_F = 0.1A$
Forward Voltage	V _F	_	0.35	0.37	V	$I_F = 0.7A$
			0.38	0.42		I _F =1.0A
Leakage Current (Note 7)	I_R		0.15	1.0	mA	$V_R = 30V, T_A = 25^{\circ}C$
Total Capacitance	C _T		40	_	pF	$V_R = 10V, f = 1.0MHz$

Notes:

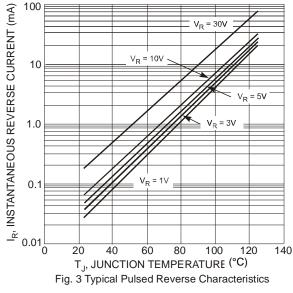
- 5. Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0".
 6. Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Incorporated, which can be found on our website at http://www.diodes.com/package-outlines.html.

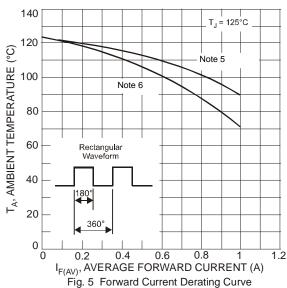
 7. Short duration pulse test used to minimize self-heating effect.











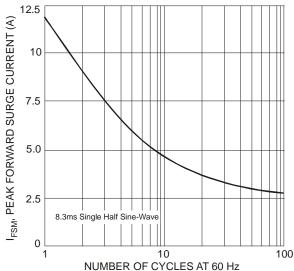
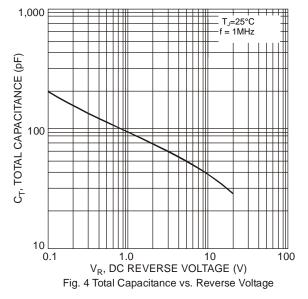
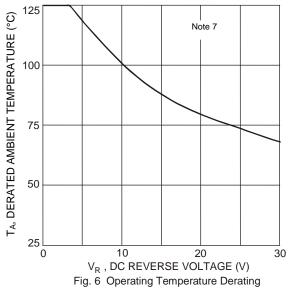


Fig. 7 Maximum Non-Repetitive Peak Forward Surge Current



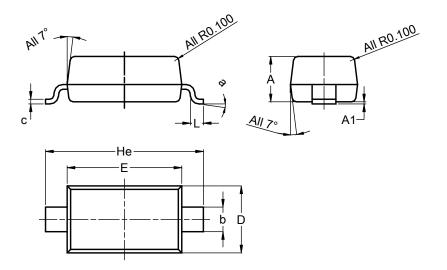




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123

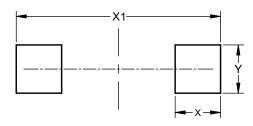


SOD123								
Dim	Min	Max	Тур					
Α	1.00	1.35	1.05					
A1	0.00	0.10	0.05					
b	0.52	0.62	0.57					
С	0.10	0.15	0.11					
D	1.40	1.70	1.55					
Е	2.55	2.85	2.65					
He	3.55	3.85	3.65					
L	0.25	0.40	0.30					
а	00	8º						
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123



Dimensions	Value (in mm)
X	0.900
X1	4.050
Y	0.950



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